
































Board Stack Report

Stack Up			Layer Stack			
Layer	Board Layer Stack	Flex	Name	Material	Thickness	Constant
1			Top Paste			
2			Top Overlay			
3			Top Solder	Solder Resist	0.40mil	3.5
4			FlexDC Top Coverlay	FC-001	0.47mil	4
5			Top Layer	Copper	1.38mil	
6			Dielectric 1	PP-018	6.00mil	4.3
7			Layer 2	Copper	1.38mil	
8			Dielectric 2	Core-023	7.50mil	4.2
9			Dielectric 10	PP-018	6.00mil	4.3
10			Layer 3	Copper	1.38mil	
11			Dielectric 3	PP-018	6.00mil	4.3
12			Layer 4	Copper	1.38mil	
13			Dielectric 8	PP-018	6.00mil	4.3
14			Dielectric 4	Core-023	7.50mil	4.2
15			Dielectric 9	PP-018	6.00mil	4.3
16			Layer 5	Copper	1.38mil	
17			Dielectric 5	PP-018	6.00mil	4.3
18			Layer 6	Copper	1.38mil	
19			Dielectric 11	PP-018	6.00mil	4.3
20			Dielectric 6	Core-023	7.50mil	4.2
21			Layer 7	Copper	1.38mil	
22			Dielectric 7	PP-018	6.00mil	4.3
23			Bottom Layer	Copper	1.38mil	
24			FlexDC Bottom Coverlay	FC-001	0.47mil	4
25			Bottom Solder	Solder Resist	0.40mil	3.5
26			Bottom Overlay			
27			Bottom Paste			
	Height : 58.32mil	Height : 45.21mil				